



# TEA1733CP

## GreenChip SMPS control IC

Rev. 2 — 15 July 2013

Product data sheet

## 1. General description

The TEA1733CP is a low cost Switched Mode Power Supply (SMPS) controller IC intended for flyback topologies. It operates in fixed frequency mode. To reduce ElectroMagnetic Interference (EMI), frequency jitter has been implemented. Slope compensation is integrated for Continuous Conduction Mode (CCM) operation.

The TEA1733CP includes OverPower Protection (OPP). This enables the controller to operate under overpower situations for a limited amount of time.

Two pins, VINSENSE and PROTECT, are reserved for protection purposes. Input UnderVoltage Protection (UVP) and OverVoltage Protection (OVP), output OVP and OverTemperature Protection (OTP) can be implemented using a minimal number of external components.

At low power levels the primary peak current is set to 25 % of the maximum peak current and the switching frequency is reduced to limit switching losses. The combination of fixed frequency operation at high output power and frequency reduction at low output power provides high-efficiency over the total load range.

The TEA1733CP enables low cost, highly efficient and reliable supplies for power requirements up to 75 W to be designed easily and with a minimum number of external components.

## 2. Features and benefits

### 2.1 Features

- SMPS controller IC enabling low-cost applications
- Large input voltage range (12 V to 30 V)
- Very low supply current during start-up and restart (typically 10 µA)
- Low supply current during normal operation (typically 0.5 mA without load)
- Overpower or high/low line compensation
- Adjustable overpower time-out
- Adjustable overpower restart timer
- Fixed switching frequency with frequency jitter to reduce EMI
- Frequency reduction with fixed minimum peak current to maintain high-efficiency at low output power levels
- Slope compensation for CCM operation
- Low and adjustable OverCurrent Protection (OCP) trip level



- Adjustable soft start operation
- Two protection inputs (for example: for input UVP and OVP, OTP and output OVP)
- IC overtemperature protection

### 3. Applications

- All applications requiring efficient and cost-effective power supply solutions up to 75 W.

### 4. Ordering information

**Table 1. Ordering information**

| Type number | Package |   | Version |
|-------------|---------|---|---------|
|             | Name    | Description                                     |         |
| TEA1733CP   | DIP8    | plastic dual in-line package; 8 leads (300 mil) | SOT97-1 |

## 5. Block diagram

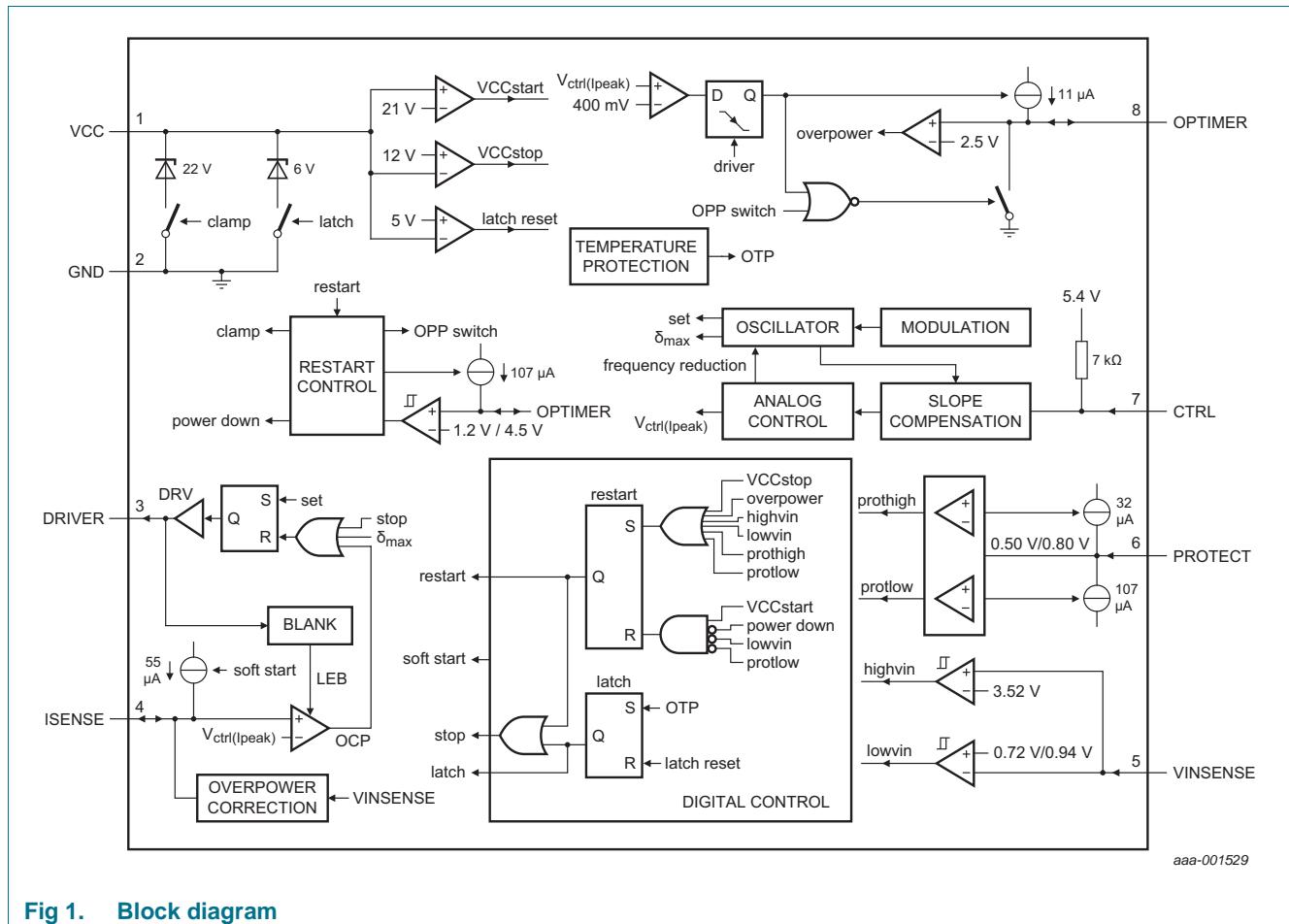
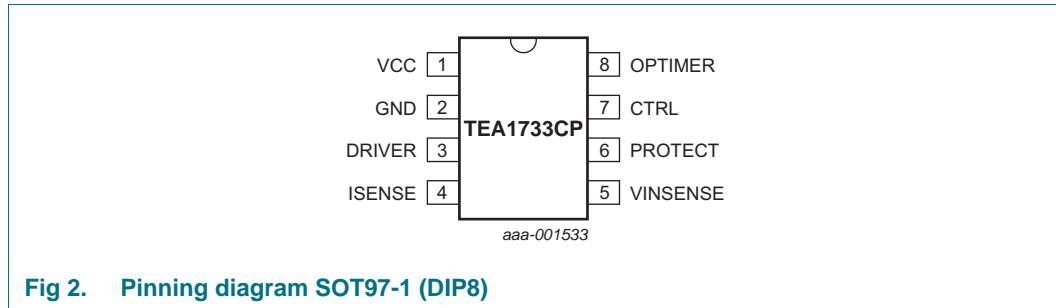


Fig 1. Block diagram

## 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

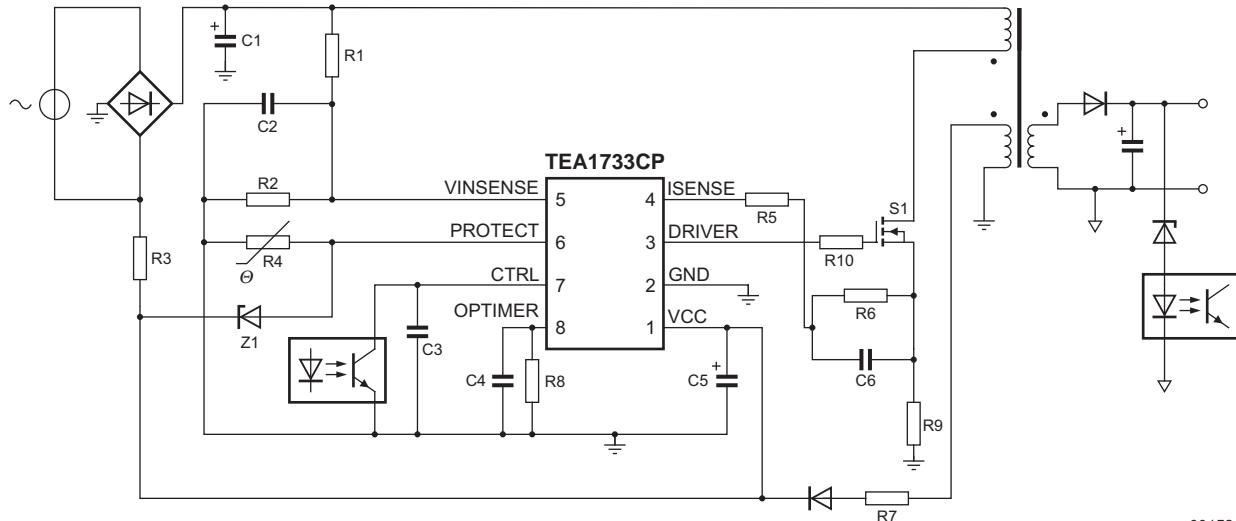
Table 2. Pin description

| Symbol   | Pin | Description                      |
|----------|-----|----------------------------------|
| VCC      | 1   | supply voltage                   |
| GND      | 2   | ground                           |
| DRIVER   | 3   | gate driver output               |
| ISENSE   | 4   | current sense input              |
| VINSENSE | 5   | input voltage protection input   |
| PROTECT  | 6   | general-purpose protection input |
| CTRL     | 7   | control input                    |
| OPTIMER  | 8   | overpower and restart timer      |

## 7. Functional description

### 7.1 General control

The TEA1733CP contains a flyback circuit controller, a typical configuration of which is shown in [Figure 3](#).



**Fig 3.** Typical configuration

### 7.2 Start-up and UnderVoltage LockOut (UVLO)

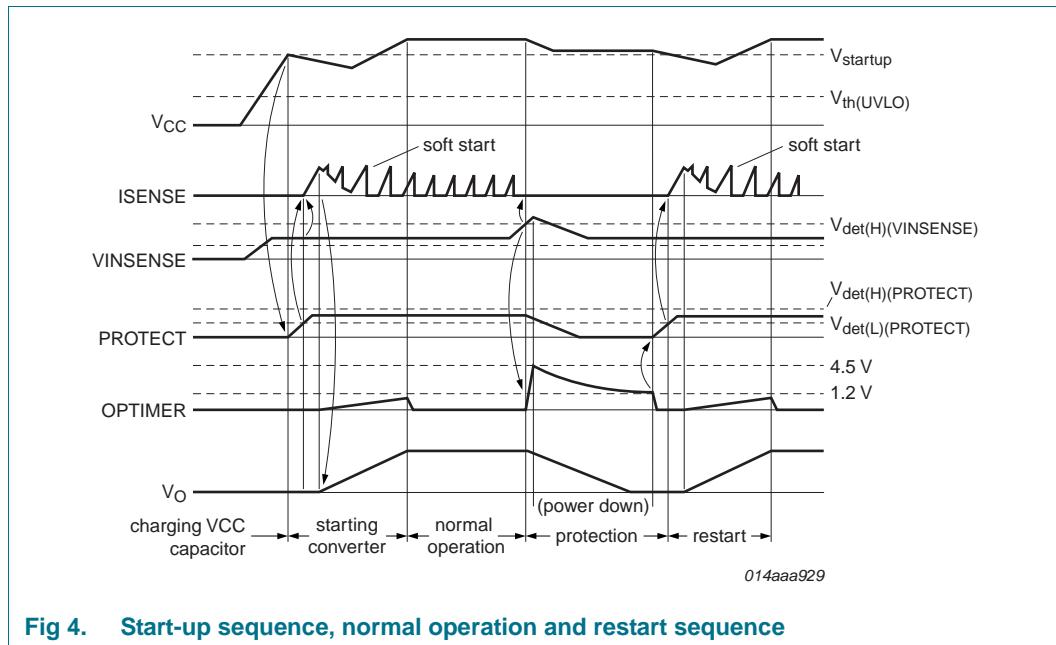
Initially, the capacitor on the VCC pin is charged from the high-voltage mains via resistor R3.

If  $V_{CC}$  is lower than  $V_{startup}$ , the IC current consumption is low (typically 10  $\mu$ A). When  $V_{CC}$  reaches  $V_{startup}$ , the IC first waits for the VINSENSE pin to reach the  $V_{start(VINSENSE)}$  voltage and PROTECT pin to reach the  $V_{det(L)}(PROTECT)$  voltage. When both levels are reached, the IC charges the ISENSE pin to the  $V_{start(soft)}$  level and starts switching. In a typical application, the auxiliary winding of the transformer takes over the supply voltage.

If a protection is triggered the controller stops switching. Depending on the protection triggered, the protection causes a restart or latches the converter to an off-state.

A restart caused by a protection rapidly charges the OPTIMER pin to 4.5 V (typical). The TEA1733CP enters Power-down mode until the OPTIMER pin discharges down to 1.2 V (typical). In Power-down mode, the IC consumes a very low supply current (10  $\mu$ A typical) and the VCC pin is clamped at 22 V (typical) by an internal clamp circuit. When the voltage on pin OPTIMER drops below 1.2 V (typical) and the VCC pin voltage is above the VCC start-up voltage (See [Figure 4](#)), the IC restarts.

When a latched protection is triggered, the TEA1733CP immediately enters Power-down mode. The VCC pin is clamped to a voltage just above the latch protection reset voltage ( $V_{rst(latch)} + 1$  V).



When the voltage on pin VCC drops below the  $V_{th(UVLO)}$  level during normal operation, the controller stops switching and enters Restart mode. In Restart mode, the driver output is disabled and the VCC pin voltage is recharged via resistor R3 to the rectified mains.

### 7.3 Supply management

All internal reference voltages are derived from a temperature compensated on-chip band gap circuit. Internal reference currents are derived from a trimmed and temperature compensated current reference circuit.

### 7.4 Input voltage detection (VINSENSE pin)

In a typical application pin VINSENSE detects the mains input voltage. Switching does not take place until the voltage on VINSENSE has reached the  $V_{start(VINSENSE)}$  voltage (0.94 V typical).

When the VINSENSE voltage drops below  $V_{det(L)(VINSENSE)}$  (typically 0.72 V) or exceeds  $V_{det(H)(VINSENSE)}$  (typically 3.52 V), the converter stops switching and performs a restart.

If pin VINSENSE is left open or disconnected, the pin is pulled up by the internal 20 nA (typical) current source to reach the  $V_{det(H)(VINSENSE)}$  level. This triggers restart protection.

An internal clamp of 5.2 V (typical) protects this pin from overvoltages.

### 7.5 Protect input (PROTECT pin)

Pin PROTECT is a general-purpose input pin, which can be used to trigger the restart protection. The converter is stopped when the voltage on this pin is pulled above  $V_{det(H)(PROTECT)}$  (typically 0.8 V) or below  $V_{det(L)(PROTECT)}$  (typically 0.5 V). A current of 32  $\mu$ A (typical) flows out of the chip when the pin voltage is at the  $V_{det(L)(PROTECT)}$  level. A current of 107  $\mu$ A (typical) flows into the chip when the pin voltage is at the  $V_{det(H)(PROTECT)}$  level.

The PROTECT input can be used to create overvoltage detection and OTP functions.

A small capacitor can be connected to the pin if the protections on this pin are not used.

An internal clamp of 4.1 V (typical) protects this pin from overvoltages.

## 7.6 Duty cycle control (CTRL pin)

Pin CTRL regulates the output power of the converter. This pin is connected to an internal 5.4 V supply using an internal 7 k $\Omega$  resistor.

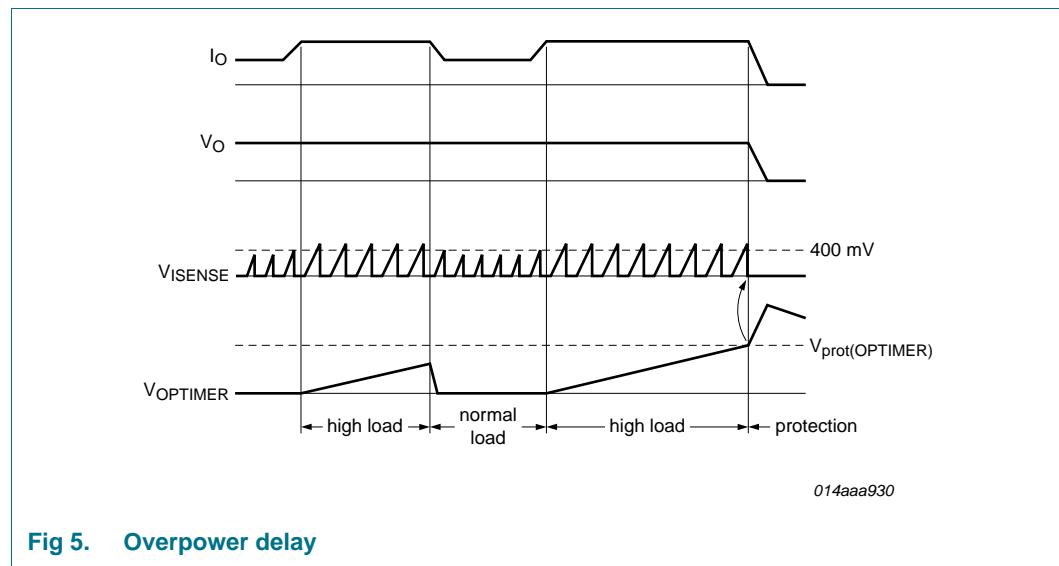
The CTRL pin voltage sets the peak current which is measured using the ISENSE pin (see [Section 7.10](#)). At a low output power the switching frequency is also reduced (see [Section 7.12](#)). The maximum duty cycle is limited to 72 % (typical).

## 7.7 Slope compensation (CTRL pin)

A slope compensation circuit is integrated in the IC for CCM. Slope compensation guarantees stable operation for duty cycles greater than 50 %.

## 7.8 Overpower timer (OPTIMER pin)

If the OPTIMER pin is connected to capacitor C4 (see [Figure 3](#)), a temporary overload situation is allowed. Pin CTRL sets  $V_{ctrl(Ipeak)}$  (see [Figure 1](#)). When  $V_{ctrl(Ipeak)}$  is above 400 mV, the  $I_{IO(OPTIMER)}$  current (11  $\mu$ A typical) is sourced from the OPTIMER pin. If the voltage on the OPTIMER pin reaches the  $V_{prot(OPTIMER)}$  voltage (2.5 V typical) the OverPower Protection (OPP) is triggered (see [Figure 5](#)).

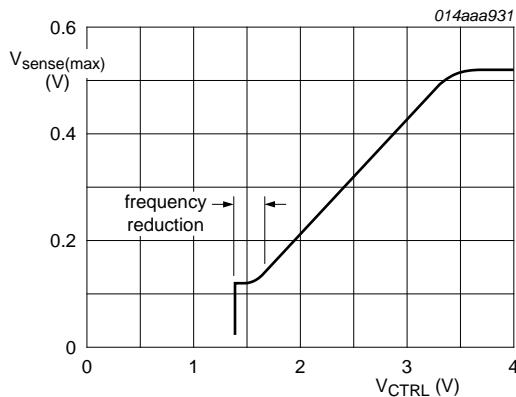


When the  $V_{prot(OPTIMER)}$  voltage is reached the device restarts. If the overload is removed before the  $V_{prot(OPTIMER)}$  voltage is reached, the converter continues switching.

## 7.9 Current mode control (ISENSE pin)

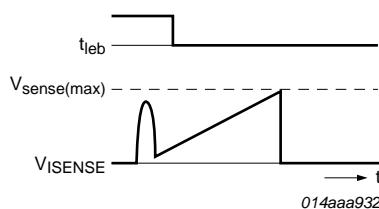
Current mode control is used for its good line regulation.

Pin ISENSE senses the primary current across an external resistor R9 (see [Figure 3](#)). This primary current is compared with an internal reference voltage. The internal reference voltage is proportional to the voltage on pin CTRL (see [Figure 6](#)).



**Fig 6. Peak current control using pin ISENSE**

Leading-edge blanking prevents false triggering due to capacitive discharge when switching on the external power switch (see [Figure 7](#)).



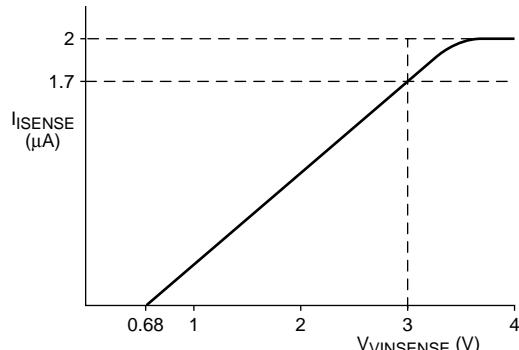
**Fig 7. Leading edge blanking using pin ISENSE**

## 7.10 Overpower or high/low line compensation (VINSENSE and ISENSE pins)

The overpower compensation function can be used to realize a maximum output power which is nearly constant over the full input mains.

The overpower compensation circuit measures the input voltage on the VINSENSE pin and outputs a proportionally dependent current on the ISENSE pin. The DC voltage across the soft start resistor limits the maximum peak current on the current sense resistor.

At low output power levels the overpower compensation circuit is switched off (See [Figure 8](#)).



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Fig 8. Overpower compensation using pins VINSENSE and ISENSE

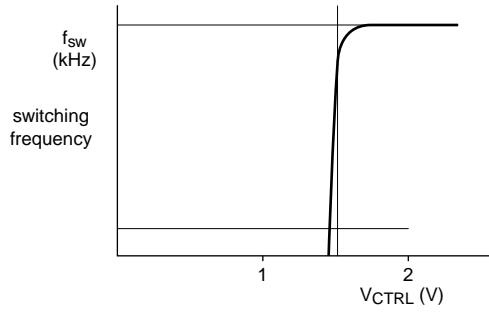
### 7.11 Soft start-up (ISENSE pin)

To prevent audible noise during start-up or a restart condition, a soft start is made. Before the converter starts, the soft start capacitor C6 (see [Figure 3](#)) on the ISENSE pin is charged. When the converter starts switching, the primary peak current slowly increases as the soft start capacitor discharges through the soft start resistor (R6, see [Figure 3](#)).

The soft start time constant is set by the soft start capacitor value chosen. The soft start resistor value must also be taken into account, but the overpower compensation (see [Section 7.10](#)) typically defines this value.

### 7.12 Low-power operation

In low-power operation switching losses are reduced by lowering the switching frequency. The converter switching frequency is reduced and the peak current is set to 25 % of the maximum peak current (see [Figure 6](#) and [Figure 9](#)).



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Fig 9. Frequency control

### 7.13 Driver (DRIVER pin)

The driver circuit to the gate of the power MOSFET has a current sourcing capability of typically  $-300\text{ mA}$  and a current sink capability of typically  $750\text{ mA}$ . This allows for a fast turn-on and turn-off of the power MOSFET for efficient operation.

## 7.14 OverTemperature Protection (OTP)

Integrated overtemperature protection ensures that the IC stops switching if the junction temperature exceeds the thermal shutdown limit.

OTP is a latched protection and it can be reset by removing the voltage on pin VCC.

## 8. Limiting values

**Table 3. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol            | Parameter                           | Conditions                   | Min  | Max  | Unit             |
|-------------------|-------------------------------------|------------------------------|------|------|------------------|
| <b>Voltages</b>   |                                     |                              |      |      |                  |
| $V_{CC}$          | supply voltage                      | continuous                   | -0.4 | +30  | V                |
|                   |                                     | $t < 100 \text{ ms}$         | -    | 35   | V                |
| $V_{VINSENSE}$    | voltage on pin VINSENSE             | current limited              | -0.4 | +5.5 | V                |
| $V_{PROTECT}$     | voltage on pin PROTECT              | current limited              | -0.4 | +5   | V                |
| $V_{CTRL}$        | voltage on pin CTRL                 |                              | -0.4 | +5.5 | V                |
| $V_{IO(OPTIMER)}$ | input/output voltage on pin OPTIMER |                              | -0.4 | +5   | V                |
| $V_{ISENSE}$      | voltage on pin ISENSE               | current limited              | -0.4 | +5   | V                |
| <b>Currents</b>   |                                     |                              |      |      |                  |
| $I_{CC}$          | current on pin VCC                  | $\delta < 10\%$              | -    | +0.4 | A                |
| $I_{I(VINSENSE)}$ | input current on pin VINSENSE       |                              | -1   | +1   | mA               |
| $I_{I(PROTECT)}$  | input current on pin PROTECT        |                              | -1   | +1   | mA               |
| $I_{CTRL}$        | current on pin CTRL                 |                              | -3   | 0    | mA               |
| $I_{ISENSE}$      | current on pin ISENSE               |                              | -10  | +1   | mA               |
| $I_{DRIVER}$      | current on pin DRIVER               | $\delta < 10\%$              | -0.4 | +1   | A                |
| <b>General</b>    |                                     |                              |      |      |                  |
| $P_{tot}$         | total power dissipation             | $T_{amb} < 75^\circ\text{C}$ | -    | 0.5  | W                |
| $T_{stg}$         | storage temperature                 |                              | -55  | +150 | $^\circ\text{C}$ |
| $T_j$             | junction temperature                |                              | -40  | +150 | $^\circ\text{C}$ |
| <b>ESD</b>        |                                     |                              |      |      |                  |
| $V_{ESD}$         | electrostatic discharge voltage     | class 1<br>human body model  | [1]  | -    | 4000 V           |
|                   |                                     | charged device model         | -    | 750  | V                |

[1] Equivalent to discharging a 100 pF capacitor through a 1.5 k $\Omega$  series resistor.

## 9. Thermal characteristics

**Table 4. Thermal characteristics**

| Symbol        | Parameter                                   | Conditions                    | Typ | Unit |
|---------------|---|-------------------------------|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air; JEDEC test board | 150 | K/W  |
| $R_{th(j-c)}$ | thermal resistance from junction to case    | in free air; JEDEC test board | 79  | K/W  |

## 10. Characteristics

**Table 5. Characteristics**

$T_{amb} = 25^\circ\text{C}$ ;  $V_{CC} = 20\text{ V}$ ; all voltages are measured with respect to ground (pin 2); currents are positive when flowing into the IC; unless otherwise specified.

| Symbol                                      | Parameter                                    | Conditions  | Min    | Typ  | Max    | Unit          |
|---|--|---|--------|--|--------|---------------|
| <b>Supply voltage management (pin VCC)</b>  |  |   |        |  |        |               |
| $V_{startup}$                               | start-up voltage                             |   | 18.6   | 20.6   | 22.6   | V             |
| $V_{th(\text{UVLO})}$                       | undervoltage lockout threshold voltage       |   | 11.2   | 12.2   | 13.2   | V             |
| $V_{clamp(VCC)}$                            | clamp voltage on pin VCC                     | activated during restart<br>activated during latched protection | -<br>- | $V_{startup} + 1$<br>$V_{rst(\text{latch})} + 1$ | -<br>- | V             |
| $V_{hys}$                                   | hysteresis voltage                           | $V_{startup} - V_{th(\text{UVLO})}$                             | 8      | 9  | 10     | V             |
| $I_{CC(\text{startup})}$                    | start-up supply current                      | $V_{CC} < V_{startup}$  | 5      | 10   | 15     | $\mu\text{A}$ |
| $I_{CC(\text{oper})}$                       | operating supply current                     | no load on pin DRIVER;<br>excluding opto current                | 0.4    | 0.5  | 0.6    | mA            |
| $V_{rst(\text{latch})}$                     | latched reset voltage                        |   | 4      | 5  | 6      | V             |
| <b>Input voltage sensing (pin VINSENSE)</b> |  |   |        |  |        |               |
| $V_{start(VINSENSE)}$                       | start voltage on pin VINSENSE                | detection level   | 0.89   | 0.94   | 0.99   | V             |
| $V_{det(L)(VINSENSE)}$                      | LOW-level detection voltage on pin VINSENSE  |   | 0.68   | 0.72   | 0.76   | V             |
| $V_{det(H)(VINSENSE)}$                      | HIGH-level detection voltage on pin VINSENSE |   | 3.39   | 3.52   | 3.65   | V             |
| $I_O(VINSENSE)$                             | output current on pin VINSENSE               |   | -      | -20  | -      | nA            |
| $V_{clamp(VINSENSE)}$                       | clamp voltage on pin VINSENSE                | $I_{I(VINSENSE)} = 50\ \mu\text{A}$                             | -      | 5.2  | -      | V             |
| <b>Protection input (pin PROTECT)</b>       |  |   |        |  |        |               |
| $V_{det(L)(PROTECT)}$                       | LOW-level detection voltage on pin PROTECT   |   | 0.47   | 0.50   | 0.53   | V             |
| $V_{det(H)(PROTECT)}$                       | HIGH-level detection voltage on pin PROTECT  |   | 0.75   | 0.8  | 0.85   | V             |

**Table 5. Characteristics ...continued**

$T_{amb} = 25^\circ\text{C}$ ;  $V_{CC} = 20\text{ V}$ ; all voltages are measured with respect to ground (pin 2); currents are positive when flowing into the IC; unless otherwise specified.

| Symbol                                    | Parameter                                    | Conditions   | Min     | Typ     | Max     | Unit                    |   |
|---|--|--|---------|---------|---------|-------------------------|---|
| $I_{O(\text{PROTECT})}$                   | output current on pin PROTECT                | $V_{\text{PROTECT}} = V_{\text{low}(\text{PROTECT})}$                                | -34     | -32     | -30     | $\mu\text{A}$           |   |
|   |  | $V_{\text{PROTECT}} = V_{\text{high}(\text{PROTECT})}$                               | 87      | 107     | 127     | $\mu\text{A}$           |   |
| $V_{\text{clamp}(\text{PROTECT})}$        | clamp voltage on pin PROTECT                 | $I_{I(\text{PROTECT})} = 200\ \mu\text{A}$   | [1]     | 3.5     | 4.1     | 4.7                     | V |
| <b>Peak current control (pin CTRL)</b>    |  |  |         |         |         |                         |   |
| $V_{\text{CTRL}}$                         | voltage on pin CTRL                          | for minimum flyback peak current   | 1.5     | 1.8     | 2.1     | V                       |   |
|   |  | for maximum flyback peak current   | 3.4     | 3.9     | 4.3     | V                       |   |
| $R_{\text{int}(\text{CTRL})}$             | internal resistance on pin CTRL              |  | 5       | 7       | 9       | $\text{k}\Omega$        |   |
| $I_{O(\text{CTRL})}$                      | output current on pin CTRL                   | $V_{\text{CTRL}} = 1.4\text{ V}$   | -0.7    | -0.5    | -0.3    | mA                      |   |
|   |  | $V_{\text{CTRL}} = 3.7\text{ V}$   | -0.28   | -0.2    | -0.12   | mA                      |   |
| <b>Pulse width modulator</b>              |  |  |         |         |         |                         |   |
| $f_{\text{osc}}$                          | oscillator frequency                         |  | 62      | 66.5    | 71      | kHz                     |   |
| $f_{\text{mod}}$                          | modulation frequency                         |  | 210     | 280     | 350     | Hz                      |   |
| $\Delta f_{\text{mod}}$                   | modulation frequency variation               |  | $\pm 3$ | $\pm 4$ | $\pm 5$ | kHz                     |   |
| $\delta_{\text{max}}$                     | maximum duty cycle                           |  | 68.5    | 72      | 79      | %                       |   |
| $V_{\text{start(red)f}}$                  | frequency reduction start                    | pin CTRL   | 1.5     | 1.8     | 2.1     | V                       |   |
| $V_{\delta(\text{zero})}$                 | zero duty cycle voltage                      | pin CTRL   | 1.25    | 1.55    | 1.85    | V                       |   |
| <b>Overpower protection (pin OPTIMER)</b> |  |  |         |         |         |                         |   |
| $V_{\text{prot(OPTIMER)}}$                | protection voltage on pin OPTIMER            |  | 2.4     | 2.5     | 2.6     | V                       |   |
| $I_{\text{prot(OPTIMER)}}$                | protection current on pin OPTIMER            | no overpower situation   | 100     | 150     | 200     | $\mu\text{A}$           |   |
|   |  | overpower situation  | -12.2   | -10.7   | -9.2    | $\mu\text{A}$           |   |
| <b>Restart timer (pin OPTIMER)</b>        |  |  |         |         |         |                         |   |
| $V_{\text{restart(OPTIMER)}}$             | restart voltage on pin OPTIMER               | low level  | 0.8     | 1.2     | 1.6     | V                       |   |
|   |  | high level   | 4.1     | 4.5     | 4.9     | V                       |   |
| $I_{\text{restart(OPTIMER)}}$             | restart current on pin OPTIMER               | charging OPTIMER capacitor   | -127    | -107    | -87     | $\mu\text{A}$           |   |
|   |  | discharging OPTIMER capacitor  | -0.1    | 0       | 0.1     | $\mu\text{A}$           |   |
| <b>Current sense (pin ISENSE)</b>         |  |  |         |         |         |                         |   |
| $V_{\text{sense(max)}}$                   | maximum sense voltage                        | $\Delta V/\Delta t = 50\text{ mV}/\mu\text{s}; V_{\text{VINSENSE}} = 0.78\text{ V}$  | 0.48    | 0.51    | 0.54    | V                       |   |
|   |  | $\Delta V/\Delta t = 200\text{ mV}/\mu\text{s}; V_{\text{VINSENSE}} = 0.78\text{ V}$ | 0.50    | 0.53    | 0.56    | V                       |   |
| $V_{\text{th(sense)opp}}$                 | overpower protection sense threshold voltage |  | 370     | 400     | 430     | mV                      |   |
| $\Delta V_{\text{ISENSE}}/\Delta t$       | slope compensation voltage on pin ISENSE     | $\Delta V/\Delta t = 50\text{ mV}/\mu\text{s}$                                       | 17      | 25      | 33      | $\text{mV}/\mu\text{s}$ |   |

**Table 5. Characteristics ...continued**

$T_{amb} = 25^\circ\text{C}$ ;  $V_{CC} = 20\text{ V}$ ; all voltages are measured with respect to ground (pin 2); currents are positive when flowing into the IC; unless otherwise specified.

| Symbol  | Parameter                                    | Conditions  | Min  | Typ              | Max   | Unit             |
|---|--|---|------|------------------|-------|------------------|
| $t_{leb}$   | leading edge blanking time                   |   | 250  | 300              | 350   | ns               |
| <b>Overpower compensation (pin VINSENSE and pin ISENSE)</b> |  |   |      |                  |       |                  |
| $I_{opc(ISENSE)}$   | overpower compensation current on pin ISENSE | $V_{VINSENSE} = 1\text{ V}$ ;<br>$V_{sense(max)} > 400\text{ mV}$ | -    | 0.28             | -     | $\mu\text{A}$    |
|   |  | $V_{VINSENSE} = 3\text{ V}$ ;<br>$V_{sense(max)} > 400\text{ mV}$ | -    | 1.7              | -     | $\mu\text{A}$    |
| <b>Soft start (pin ISENSE)</b>                              |  |   |      |                  |       |                  |
| $I_{start(soft)}$   | soft start current                           |   | -63  | -55              | -47   | $\mu\text{A}$    |
| $V_{start(soft)}$   | soft start voltage                           | $V_{CTRL} = 4\text{ V}$ ; enable voltage                          | -    | $V_{sense(max)}$ | -     | V                |
| $R_{start(soft)}$   | soft start resistance                        |   | 12   | -                | -     | $\text{k}\Omega$ |
| <b>Driver (pin DRIVER)</b>                                  |  |   |      |                  |       |                  |
| $I_{source(DRIVER)}$  | source current on pin DRIVER                 | $V_{DRIVER} = 2\text{ V}$   | -    | -0.3             | -0.25 | A                |
| $I_{sink(DRIVER)}$  | sink current on pin DRIVER                   | $V_{DRIVER} = 2\text{ V}$   | 0.25 | 0.3              | -     | A                |
|   |  | $V_{DRIVER} = 10\text{ V}$  | 0.6  | 0.75             | -     | A                |
| $V_{O(DRIVER)max}$  | maximum output voltage on pin DRIVER         |   | 9    | 10.5             | 12    | V                |
| <b>Temperature protection</b>                               |  |   |      |                  |       |                  |
| $T_{pl(IC)}$  | IC protection level temperature              |   | 130  | 140              | 150   | $^\circ\text{C}$ |

[1] The clamp voltage on the PROTECT pin is lowered when the IC is in power-down (latched or restart protection).

## 11. Application information

A power supply with the TEA1733CP is a flyback converter operating in Continuous conduction mode (See [Figure 10](#)).

Capacitor C5 buffers the IC supply voltage, which is powered via resistor R3 at start-up and via the auxiliary winding during normal operation. Sense resistor R9 converts the current through the MOSFET S1 into a voltage on pin ISENSE. The value of R9 defines the maximum primary peak current on MOSFET S1. Resistor R7 reduces the peak current to capacitor C5.

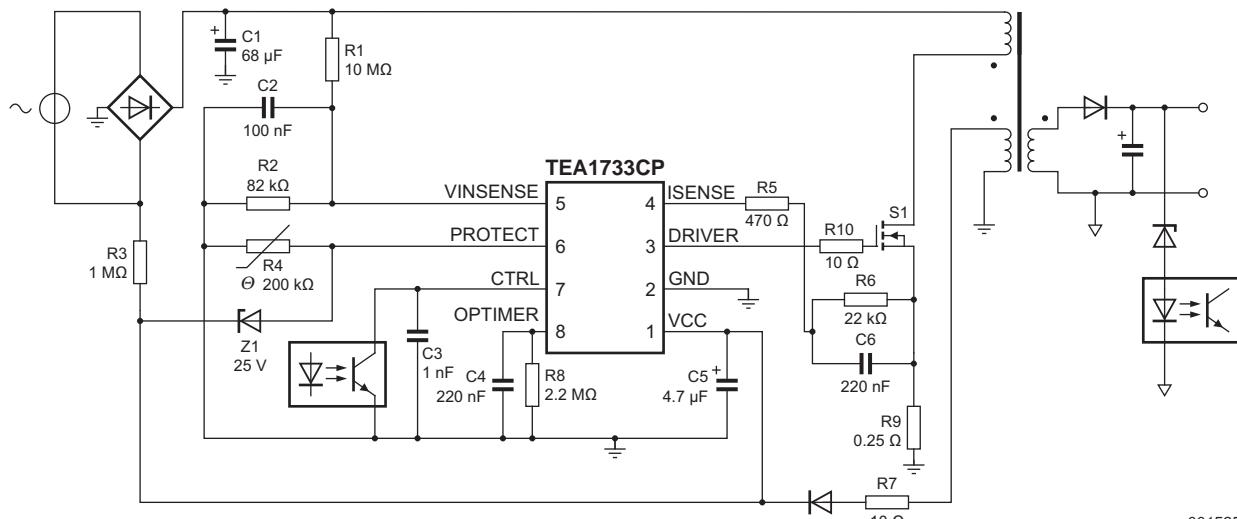
In the example shown in [Figure 10](#), the PROTECT pin is used for OVP and OTP. Diode Z1 sets the OVP level to  $V_{CC} = 25.8\text{ V}$ . Negative Temperature Coefficient (NTC) resistor R4 sets the OTP level. The VINSENSE pin is used for mains voltage detection and resistors R1 and R2 set the start voltage to about 80 V (AC). Capacitor C4 sets the overpower protection time at 60 ms.

Capacitor C4 and resistor R8 set the restart time at 0.5 s.

Resistor R6 and capacitor C6 define the soft start time. Resistor R5 prevents the soft start capacitor C6 from being charged during normal operation caused by negative voltage spikes across the current sense resistor R9.

Capacitor C3 reduces noise on the CTRL pin.

See the application note for more information ([Ref. 1](#)).



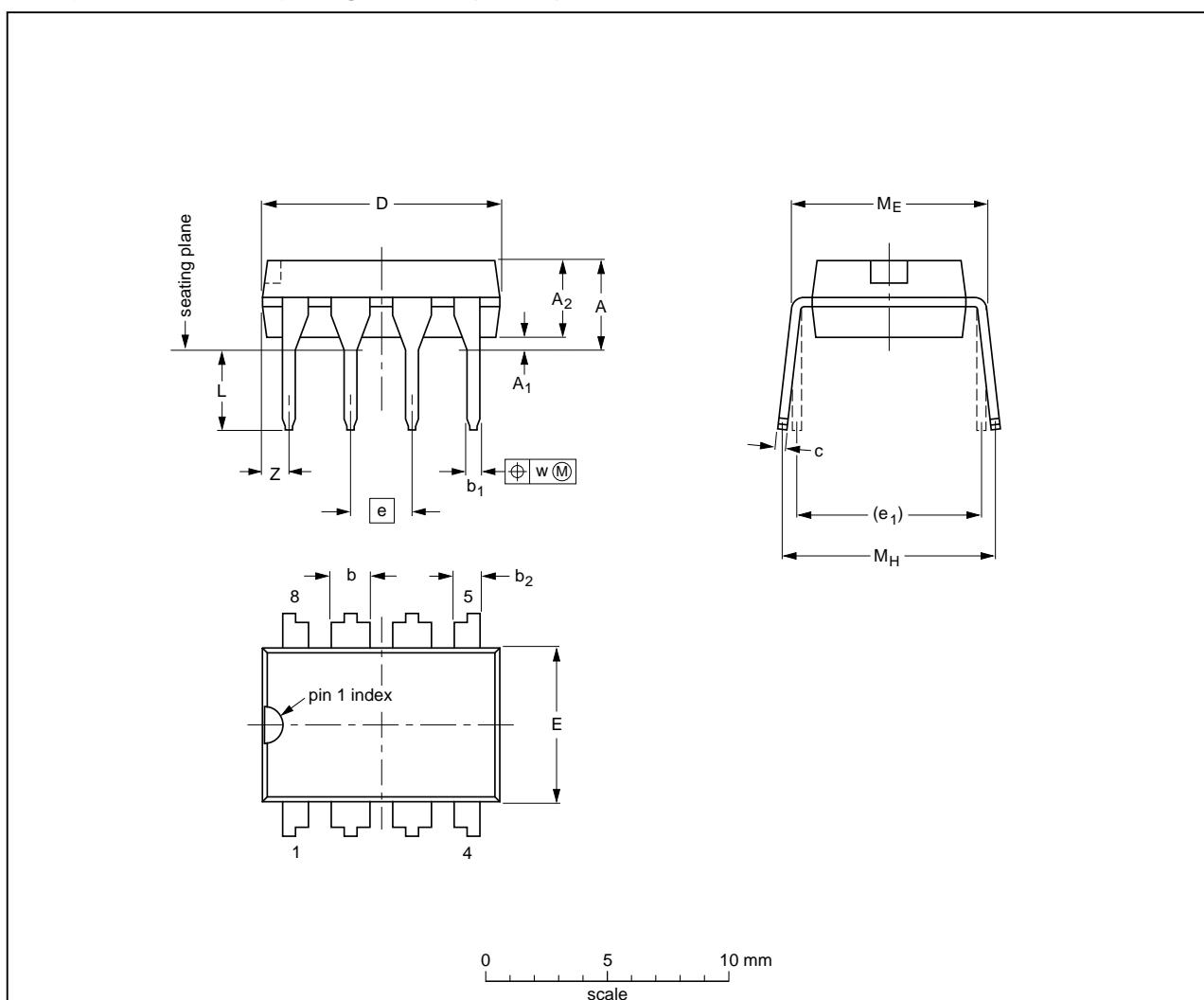
aaa-001535

**Fig 10. Typical application**

## 12. Package outline

DIP8: plastic dual in-line package; 8 leads (300 mil)

SOT97-1



**DIMENSIONS** (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max. | A <sub>1</sub><br>min. | A <sub>2</sub><br>max. | b              | b <sub>1</sub> | b <sub>2</sub> | c              | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | e <sub>1</sub> | L            | M <sub>E</sub> | M <sub>H</sub> | w     | Z <sup>(1)</sup><br>max. |
|--------|-----------|------------------------|------------------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|----------------|----------------|-------|--------------------------|
| mm     | 4.2       | 0.51                   | 3.2                    | 1.73<br>1.14   | 0.53<br>0.38   | 1.07<br>0.89   | 0.36<br>0.23   | 9.8<br>9.2       | 6.48<br>6.20     | 2.54 | 7.62           | 3.60<br>3.05 | 8.25<br>7.80   | 10.0<br>8.3    | 0.254 | 1.15                     |
| inches | 0.17      | 0.02                   | 0.13                   | 0.068<br>0.045 | 0.021<br>0.015 | 0.042<br>0.035 | 0.014<br>0.009 | 0.39<br>0.36     | 0.26<br>0.24     | 0.1  | 0.3            | 0.14<br>0.12 | 0.32<br>0.31   | 0.39<br>0.33   | 0.01  | 0.045                    |

**Note**

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |          |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|--------|----------|--|------------------------|----------------------|
|                    | IEC        | JEDEC  | JEITA    |  |                        |                      |
| SOT97-1            | 050G01     | MO-001 | SC-504-8 |  |                        | 99-12-27<br>03-02-13 |

**Fig 11. Package outline SOT97-1 (DIP8)**

## 13. References

- [1] AN10868 — GreenChip TEA1733 series fixed frequency flyback controller

## 14. Revision history

**Table 6. Revision history**

| Document ID    | Release date | Data sheet status  | Change notice | Supersedes    |
|----------------|--------------|--|---------------|---------------|
| REA1733CP v.2  | 20130715     | Product data sheet   | -             | TEA1733CP v.1 |
| Modifications: |              | <ul style="list-style-type: none"><li>• <a href="#">Section 11 "Application information"</a> has been updated.</li><li>• <a href="#">Section 13 "References"</a> has been added.</li></ul> |               |               |
| TEA1733CP v.1  | 20120119     | Product data sheet   | -             | -             |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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